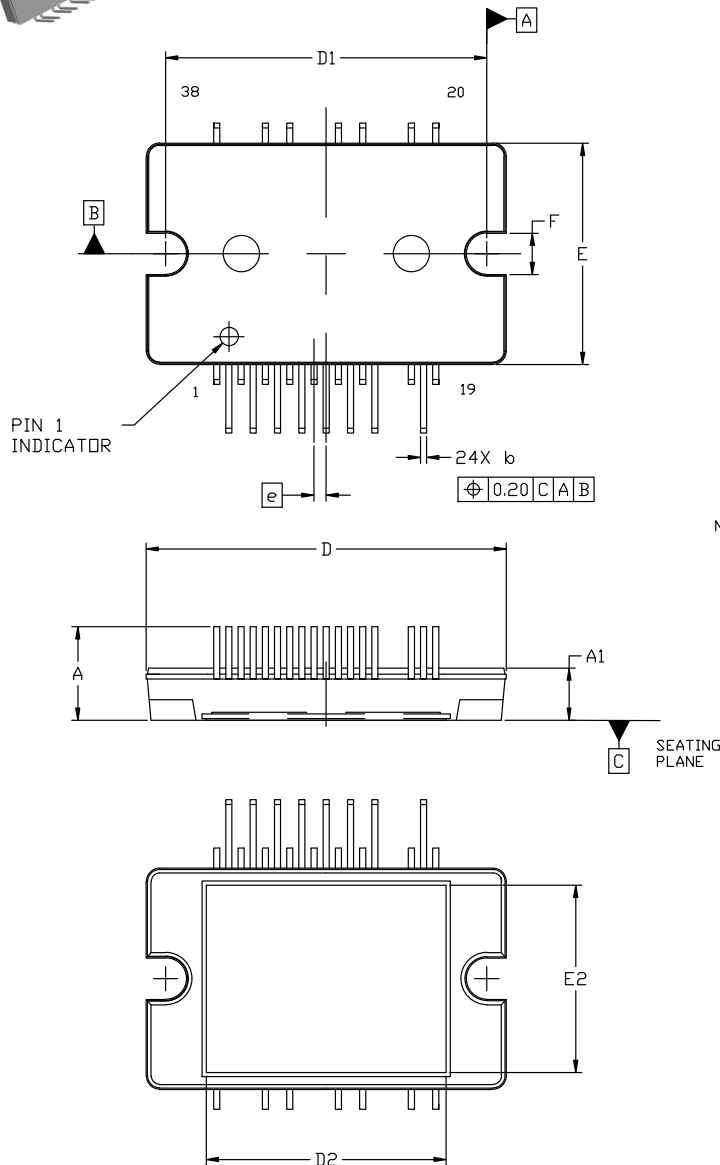


DIP38, 29.60x18.20x7.70, 1.00P (EP-4)
CASE 125BS
ISSUE B

DATE 26 APR 2023

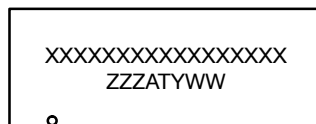


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO THE PLATED LEAD AND IS MEASURED BETWEEN 0.10 AND 0.25 FROM THE LEAD TIP.
4. PACKAGE IS MISSING PINS: 15, 16, 21, 23, 24, 25, 27, 29, 30, 31, 33, 35, 36, AND 37.

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	7.20	7.70	8.20
A1	4.00	4.30	4.60
A2	3.10	3.40	3.70
b	0.40	0.50	0.60
c	0.35	0.40	0.60
D	29.10	29.60	30.10
D1	26.30	26.40	26.50
D2	19.20	19.70	20.20
E	17.70	18.20	18.70
E2	14.90	15.40	15.90
E3	19.50	20.00	20.50
E4	20.00	20.50	21.00
E5	3.50	4.00	4.50
e	1.00 BSC		
F	2.90	3.40	3.90
G	4°	5°	6°

GENERIC
MARKING DIAGRAM*



XXXX = Specific Device Code
ZZZ = Lot ID
AT = Assembly & Test Location
Y = Year
WW = Work Week

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	DIP38, 29.60x18.20x7.70, 1.00P (EP-4)	PAGE 1 OF 1

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